

MB86H55/MB86H56

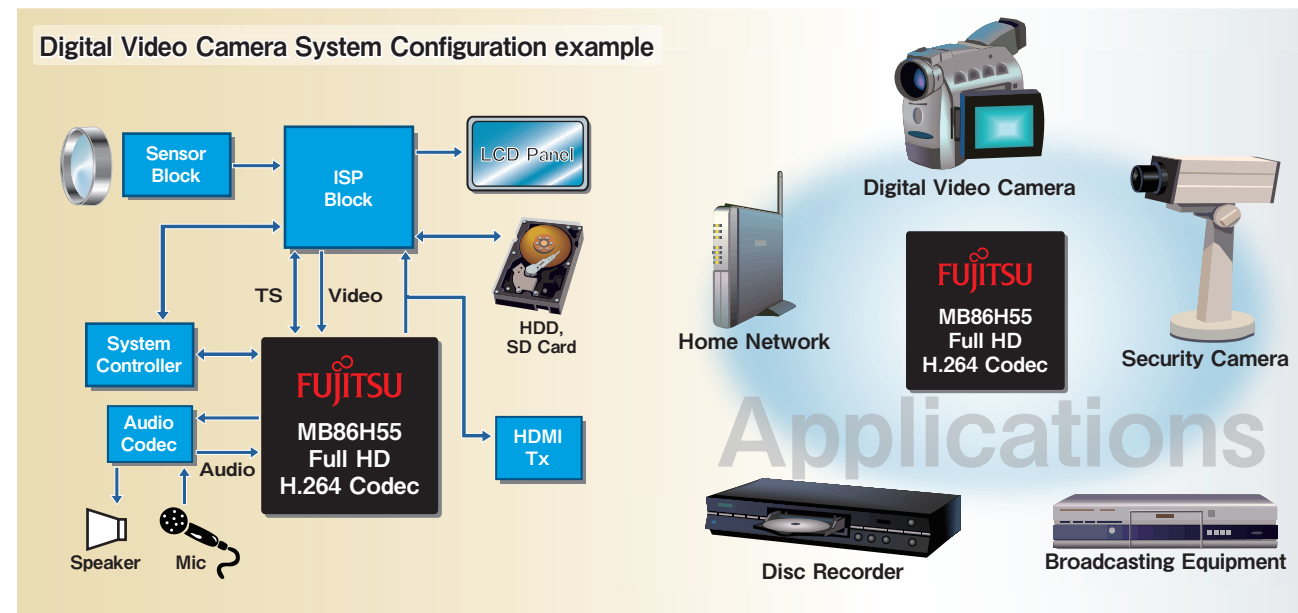
Ultra Low Power Full HD H.264 Codec

Introduction

The Fujitsu MB86H55, MB86H56 can compress and decompress full High-Definition (HD) video (1920 dots x 1080 lines) in the H.264 format in real-time.

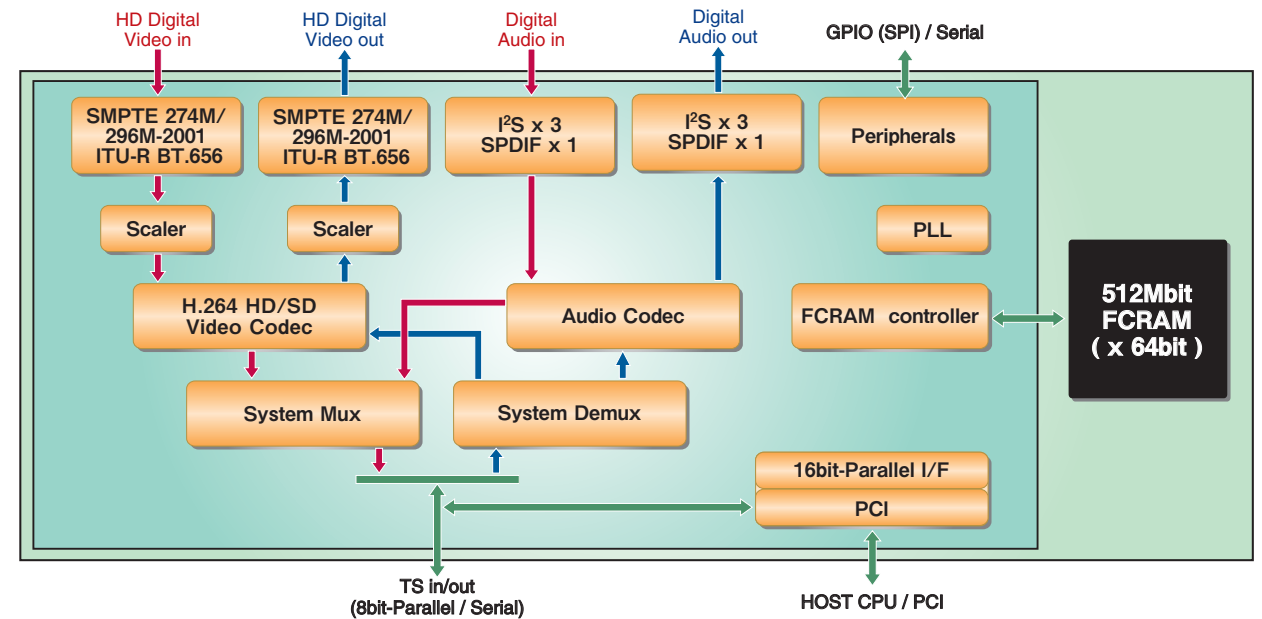
The two products feature power consumption of only 500mW during Full HD encoding including the in-package memory, an industry-leading level for low power consumption. In addition, MB86H56 offers processing of Full HD video at 60p, to improve picture quality even further.

These two products have memory in-package to offer a small package size of 15mm x 15mm, thus making it ideal to record, play and transmit superior picture quality HD video on portable devices such as digital camcorders, as well as on home networked appliances, commercial broadcast equipment, and security cameras.



Features

- Small form-factor, low power consumption necessary for portable devices**
Both new products contain one 512M bit memory in-package. Due to the reduction in the number of memory chips, as well as the usage of 65nm process technology, the power consumption during Full HD encoding, including the in-package memory, is reduced to 500mW (at 60i). Also, it is provided in a small form-factor, 15mm x 15mm package.
- Processing at 60p further improves picture quality (MB86H56)**
The existing CODEC product, MB86H51, processes video at 30 frames per second(60i); while the new MB86H56 doubles this to 60 frames per second, 60p, to boost picture quality.
- Both LSIs feature embedded Up/Down scaler**
Both products have an embedded scaler for expansion or reduction of the picture. In units of 16 bit x 32 lines, pictures can be expand by a maximum of 6 times or reduced to 1/6.
- Improved connectivity to peripheral LSIs**
Both products contain many interfaces for improved connectivity. There is a 16 bit parallel interface and a TS interface as the video stream interface. In addition, there is a serial interface in which a reduction of pins for host interface is possible, as well as a PCI interface for connecting a PC or a recorder. Connection to external ROM is also possible, thus realizing high-speed boot for devices that feature this LSI.



Specifications

Video	Profile	MB86H55 : H.264 High profile / Level 4.0 Half -Duplex Codec MB86H56 : H.264 High profile / Level 4.2*1 Half -Duplex Codec
Resolution		1920 x 1080 x 60p/50p (MB86H56 only), 1920 x 1080 x 60i/50i/30p/24p, 1440 x 1080 x 60i/50i/30p/24p, 1280 x 720 x 60p/50p, 720 x 480 x 60i, 720 x 576 x 50i Up/Down scaler embedded
Bit Rate		MB86H55 : 24Mbps(max.) , MB86H56 : 30Mbps(max.)
Interface		SMPTE 274M / SMPTE296M-2001, ITU-R BT.656, External sync mode (H/V/F + 16bit data)
Audio	Format	Dolby® Digital(AC-3)*2, MPEG-2/4 AAC(LC profile), MPEG-1 Audio Layer2, Linear PCM
	Channels	Max. 5.1 ch*3
	Interface	I ² S, S/PDIF
System	Format	ISO/IEC13818-1+Amd3(MPEG-2 TS), Video/Audio ES output
	Interface	8bit parallel, Serial, PCI
Host Interface		General 16bit parallel, Serial, PCI
Peripheral I/O		SPI
Input Clock Frequency		27MHz
Operating Frequency		MB86H55 : 108MHz (internal memory interface only: 135MHz) MB86H56 : 189MHz (internal memory interface only: 189MHz)
Power Consumption (including memory)		MB86H55 : 500mW (typ., 1.2V, 1920x1080x60i at encoding) MB86H56 : 850mW (typ., 1.2V, 1920x1080x60p at encoding)
Package		FBGA 650pin 15mm square SiP (Ball pitch 0.5mm)
Memory		512Mbit FCRAM x 1

*1 Support up to a maximum of 30Mbps bit rate.
*2 Dolby is a registered trademark of Dolby Laboratories.
*3 Number of channels depend on audio format.

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